



Preparation and characterization of reduced graphene oxide/copper composites incorporated with nano-SiO₂ particles



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ABSTRACT

Reduced graphene oxide/copper (rGO/Cu) composites incorporated with nano-SiO₂ particles were successfully fabricated using the raw materials of GO dispersion, hydrophilic nano-SiO₂ and electrolytic Cu powder. The as-prepared composites were characterized by X-ray diffraction, field-emission scanning electron microscope and energy dispersive spectroscopy. Microstructural observation of the composite powders indicated that the graphene oxide (GO) was effectively reduced by N₂H₄·H₂O addition in the composite slurry, and the nano-SiO₂ particles and rGO sheets were randomly and completely mixed with Cu particles. The as-sintered composites exhibited the small rGO agglomerations in the Cu matrix, and the more nano-SiO₂ additions led to the agglomerations increase. The mechanical property testing revealed that rGO/Cu composites with nano-SiO₂ incorporation exhibited the higher hardness and strength, compared with the rGO/Cu composite and as-cast pure Cu. However, the strengthening in the composites with higher SiO₂ content accompanied with the expense of compressive ductility. Microstructural formation and strengthening mechanism of the composites are also discussed in details.

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1. Introduction

Copper and its alloys have been widely applied as the structural materials for engineering applications due to their excellent electrical conductivity, thermal conductivity and chemical stability [1–3]. However, these materials suffer some problems like corrosion and inferior high-temperature properties, thereby greatly limiting their uses [1,4]. Hence there lies a challenge to improve the room- and high-temperature strength and wear resistance of Cu and its alloys at operating temperature [1]. Their performance enhancement is increasingly required to develop new structural materials in order to extend their application.

Recently, the introduction of secondary-phases in Cu and its alloys matrix to fabricate Cu-based composites, has developed as one of the efficient strategies to achieve superior properties. These composites possess the excellent thermal and electrical

conductivity, high corrosion resistance, anti-friction and anti-wear ability over Cu and its alloys [5–8]. In such composites, some secondary-phases, such as TiC [1,8], SiC [9], Al₂O₃ [10], graphite [11], diamond [11,12], etc, were widely incorporated into Cu matrix, and several processing techniques have been explored and employed to synthesize such composites [5–12]. Interestingly, as the attractive reinforcement medium of Cu-based composites, various carbon materials like graphite and carbon nanotubes have been extensively investigated due to their excellent mechanical, thermal, electrical and wear-resistant properties [5,11]. And, above all, the addition of various carbon materials exhibited many significant property enhancements (especially strength, electrical conductivity and wear resistance) to Cu matrix [5,11,13]. As a two-dimensional carbon atoms layer, the graphene possesses the high Young's modulus (1 TPa) [14], high fracture strength (125 GPa) [14] and extreme thermal conductivity (5000 Wm⁻¹ K⁻¹) [15]. It has recently attracted tremendous attention as a reinforcing agent for developing metal matrix composites [16,17]. Thereinto, some methods have been employed to synthesize graphene/Cu composites, such as high-ratio differential speed rolling technique,

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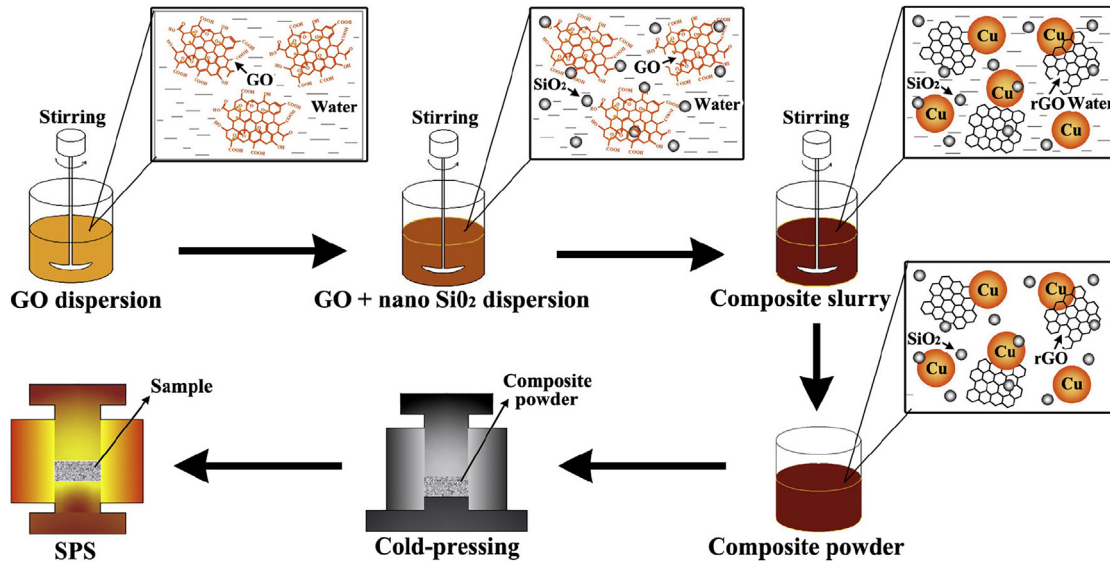


Fig. 1. Schematic illustration of fabrication process of rGO/Cu composites incorporated with nano-SiO₂ particles.

Table 1

The nominal composition of rGO/Cu composites incorporated with nano-SiO₂ particles.

Composites	Cu (wt.%)	rGO (wt.%)	Nano-SiO ₂ (wt.%)	Mass ratio (rGO: Nano-SiO ₂)
#1	97.5	2.5	0	0
#2	97.0	2.5	0.5	5:1
#3	96.0	2.5	1.5	5:3
#4	95.0	2.5	2.5	1:1

mechanical properties and being an excellent potential reinforcement in the composites. Some reports show that the addition of nano-SiO₂ particles significantly improved the concrete and ceramic properties [21,22]. Especially, the import of nano-SiO₂ particles also led to some novel properties in nano-SiO₂/metal composites. For instance, the nano-SiO₂ added Ni–W composites exhibited improved hardness and corrosion resistance, and the nano-SiO₂/Ni composites showed improved wear resistance with increasing

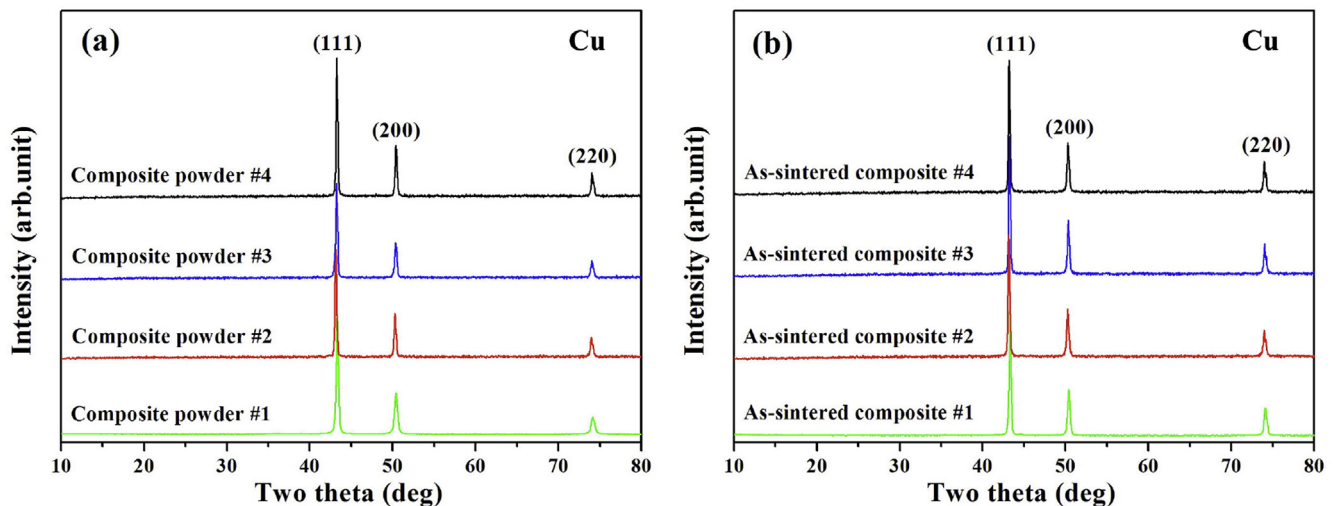


Fig. 2. X-ray diffraction patterns of the freeze-dried composite powders (a) and as-sintered composite samples by SPS (b).

CVD-grown and chemical reduction [17–19]. Kim et al. [18] prepared multi-layer graphene/Cu composites using high-ratio differential speed rolling, and found that the addition of graphene improved the strength of Cu matrix. However, some reports focused on the reduced graphene oxide (rGO)/Cu nonacomposites using the chemical reduction of copper ions and GO. Interestingly, the excellent interfacial bonding and enhancing strength and wear resistance of rGO to Cu matrix were confirmed [17,20].

Nano SiO₂, a common nanoparticle, possesses some outstanding

nano-SiO₂ particle content [23–25]. In addition, after incorporating with nano-SiO₂, the graphene/SiO₂ composites showed the better thermal conductivity, as well as enhanced electro-chemical performance [26,27]. Herein, to combine the merits of nano-SiO₂ and rGO, we synthesized the reduced graphene oxide/copper (rGO/Cu) composites incorporated with nano-SiO₂ particles through a combined methodology based on freeze-drying and spark plasma sintering, using the raw materials of GO dispersion, hydrophilic nano-SiO₂ and electrolytic Cu powder. Microstructural characteristic and

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